

Surface-Mount Ultrafast Plastic Rectifier


SMC (DO-214AB)

Cathode Anode

LINKS TO ADDITIONAL RESOURCES


[3D Models](#)

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3.0 A
V_{RRM}	100 V, 150 V, 200 V
I_{FSM}	100 A
t_{rr}	20 ns
V_F at $I_F = 3.0$ A	0.74 V
T_J max.	150 °C
Package	SMC (DO-214AB)
Circuit configuration	Single

FEATURES

- Oxide planar chip junction
- Ultrafast recovery time
- Low forward voltage, low power losses
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
 COMPLIANT
 HALOGEN
FREE

TYPICAL APPLICATIONS

For us in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

MECHANICAL DATA

Case: SMC (DO-214AB)

Molding compound meets UL 94 V-0 flammability rating
 Base P/N-E3 - RoHS-compliant, commercial grade
 Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 and M3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	U3B	U3C	U3D	UNIT	
Device marking code		U3B	U3C	U3D		
Maximum repetitive peak reverse voltage	V_{RRM}	100	150	200	V	
Maximum average forward rectified current (fig. 1)	$T_M = 134$ °C	$I_{F(AV)}^{(1)}$	2.0		A	
	$T_M = 125$ °C	$I_{F(AV)}^{(2)}$	3.0			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I_{FSM}	100		A	
Operating junction and storage temperature range		T_J, T_{STG}	-55 to +150		°C	

Notes

(1) Free air, mounted on recommended copper pad area

(2) Units mounted on PCB with 0.47" x 0.47" (12 mm x 12 mm) copper pad areas



ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 3.0\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.85	0.90	V
		$T_A = 100\text{ }^\circ\text{C}$		0.74	0.83	
Reverse current	Rated V_R	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	10	μA
		$T_A = 100\text{ }^\circ\text{C}$		250	500	
Reverse recovery time	$I_F = 0.5\text{ A}$, $I_R = 1.0\text{ A}$, $I_{rr} = 0.25\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	t_{rr}	-	20	ns
		$T_A = 25\text{ }^\circ\text{C}$		25	30	
		$T_A = 100\text{ }^\circ\text{C}$		35	50	
Storage charge	$I_F = 3.0\text{ A}$, $dI/dt = 50\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$, $I_{rr} = 0.1\text{ I}_{RM}$	$T_A = 25\text{ }^\circ\text{C}$	Q_{rr}	9	15	nC
		$T_A = 100\text{ }^\circ\text{C}$		22	35	
Typical junction capacitance	4.0 V, 1 MHz		C_J	25	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	U3B	U3C	U3D	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	92			$^\circ\text{C}/\text{W}$
	$R_{\theta JM}^{(1)}$	10			

Note

- (1) Free air, mounted on recommended copper pad area. Thermal resistance $R_{\theta JA}$ - junction to ambient, $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
U3D-E3/57T	0.239	57T	850	7" diameter plastic tape and reel
U3D-E3/9AT	0.239	9AT	3500	13" diameter plastic tape and reel
U3D-M3/57T	0.239	57T	850	7" diameter plastic tape and reel
U3D-M3/9AT	0.239	9AT	3500	13" diameter plastic tape and reel

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

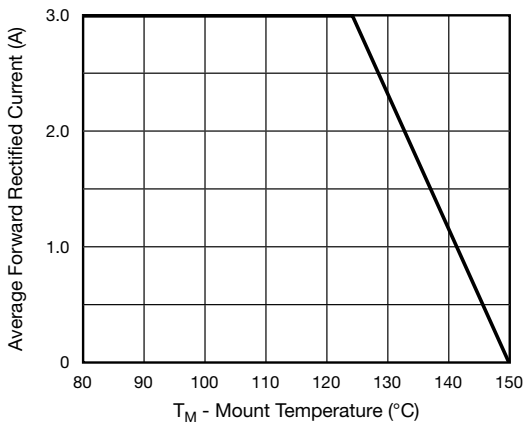


Fig. 1 - Maximum Forward Current Derating Curve

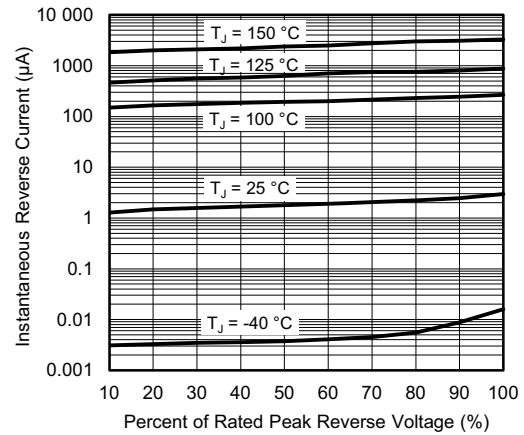


Fig. 4 - Typical Reverse Leakage Characteristics

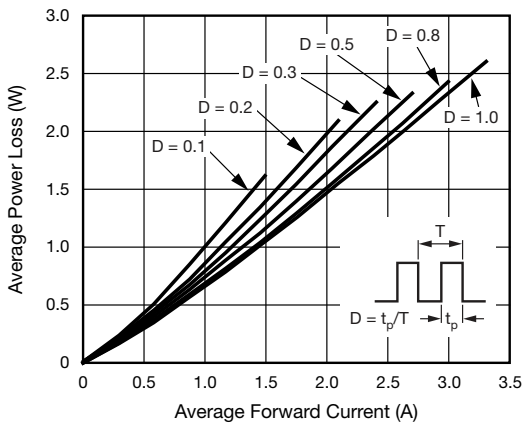


Fig. 2 - Forward Power Loss Characteristics

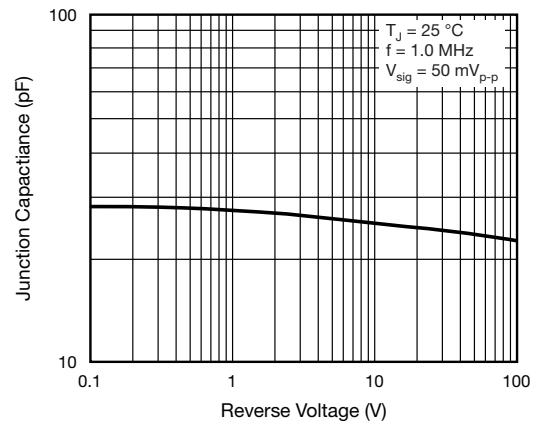


Fig. 5 - Typical Junction Capacitance

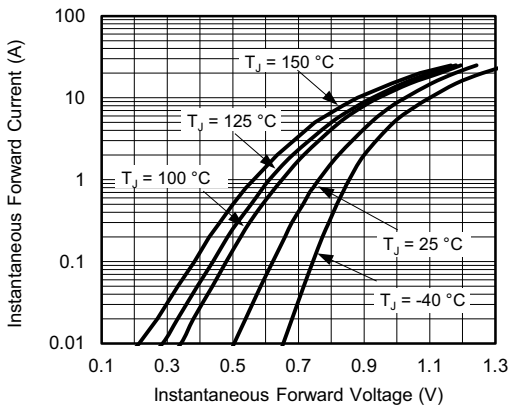


Fig. 3 - Typical Instantaneous Forward Characteristics

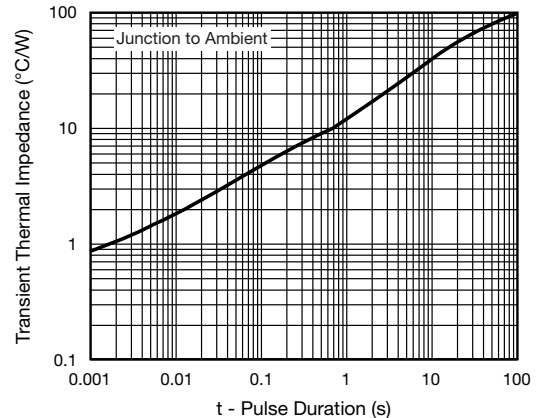
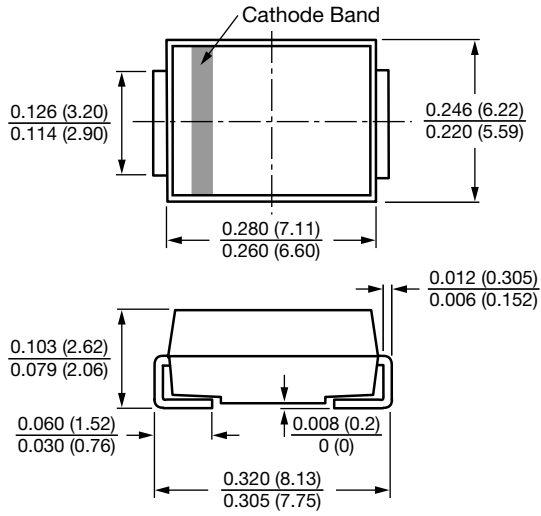


Fig. 6 - Typical Transient Thermal Impedance

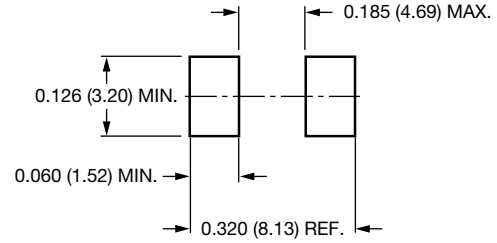


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMC (DO-214AB)



Mounting Pad Layout





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